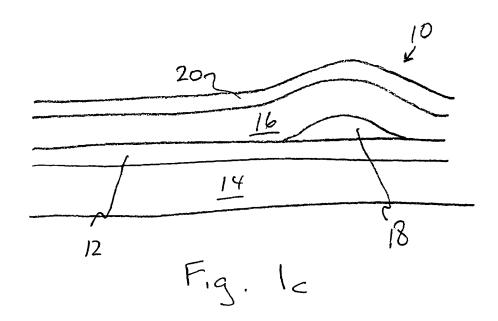
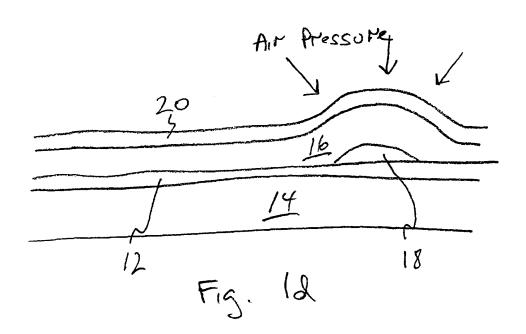
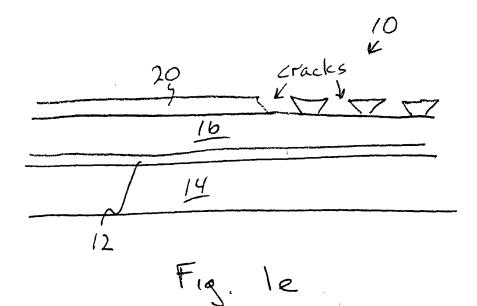


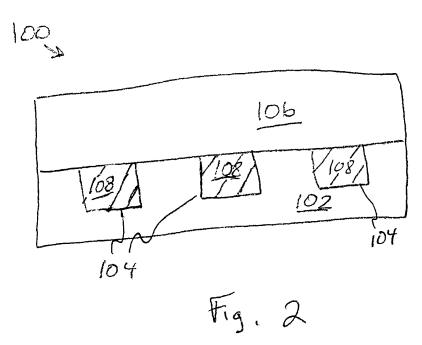
Fig. 16

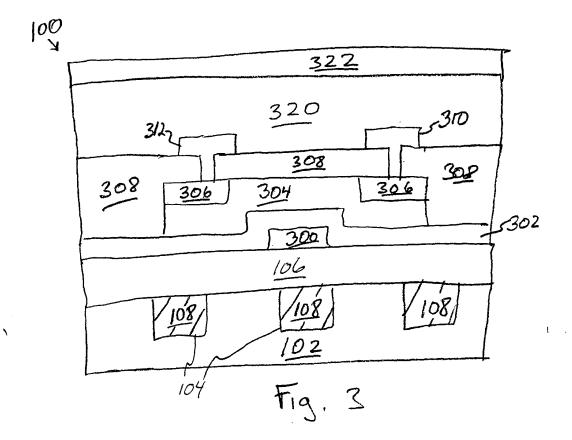


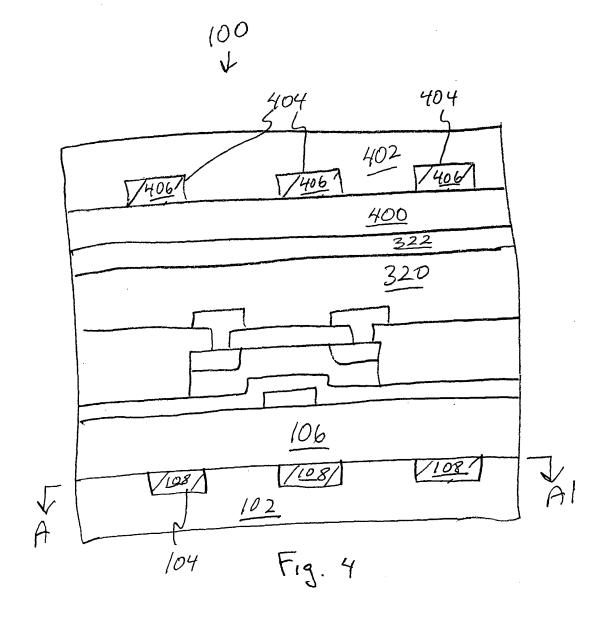


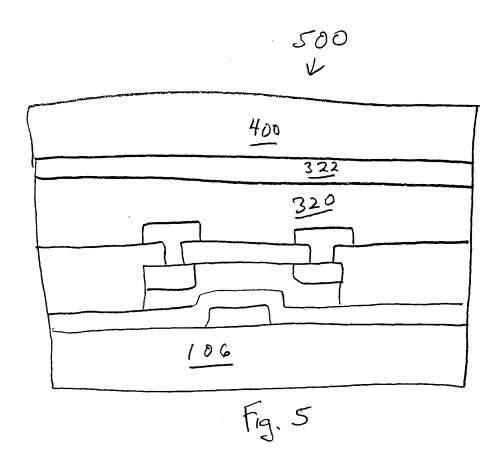
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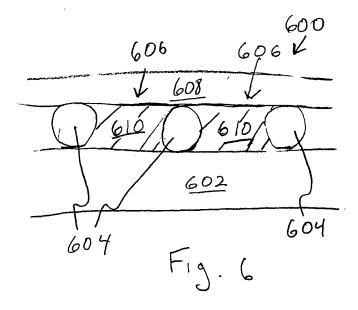












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Fig. 7

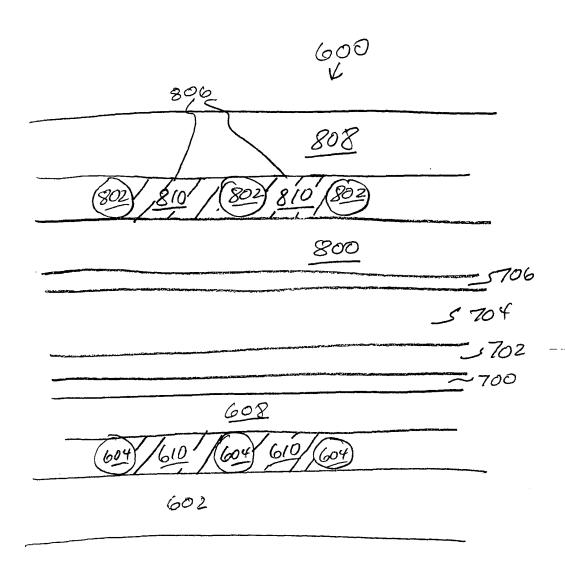


Fig. 8

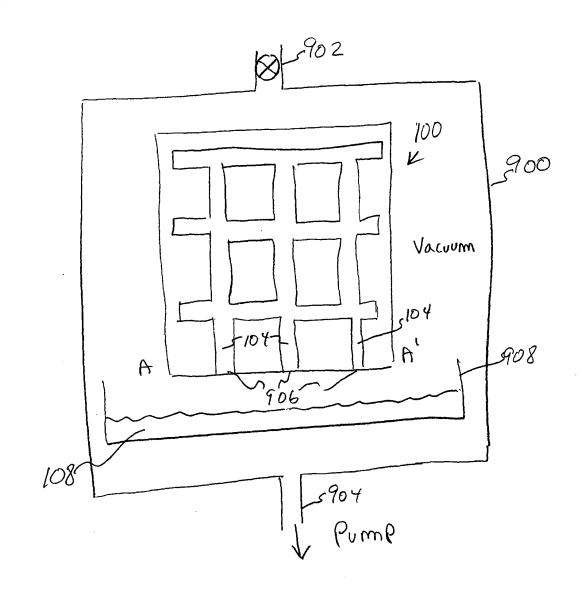


Fig. 9a

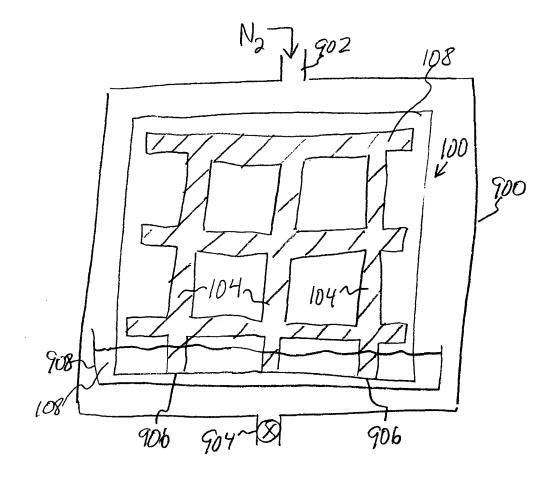


Fig. 96

		000
Fig. 10	(Start)	100,2
forming	rigid Supports	substrate
Cormins	flexible sub.	strate 1004
	ng adhesive F	1006
	q vacuum)	006a 1006b
SUPPLY	ing adhesive to	o treneh mouth
Pulling	adhesive into	Trench 1006c
Curing	adhesive 100	1810
[deposi-	ting 1¢ film	
Formin	g hC layer/	1012
formi	ig color fil-	ter) 1016
Formin	3 flexible su	bstrate 1018
formin	is risid sup	Port Substrate
linde	ting adhesive	
TOT!	7	ut substrate
LO	the state of the s	

1100 Fig. START NOS Misid support substrate Cormina 06 forming flexibe substrate insecting adhesive 75/108 Creating Vacuum Supplying glue to spacer channels 1108cz/returning to ambient pressure 1108dy Pulling adhesive into spacer channel 1110 Curing adhesive Lepositing forming forming color filter flexible Substra to rming distributing spacersts rigid support substrate torming adhesive/1124 adhesive 751126 detacting support substrate